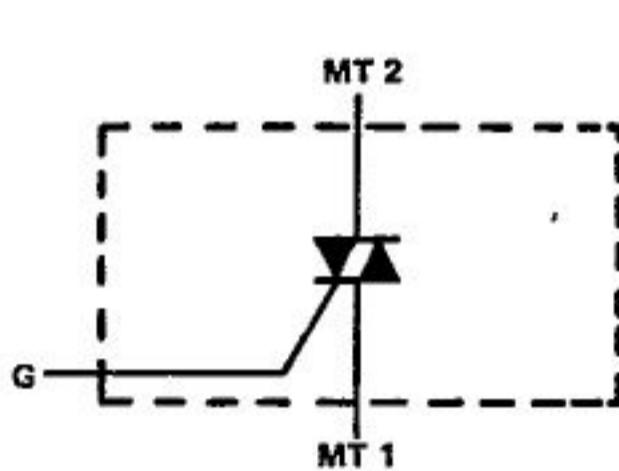


SERIES TIC236, TIC246 SILICON TRIACS

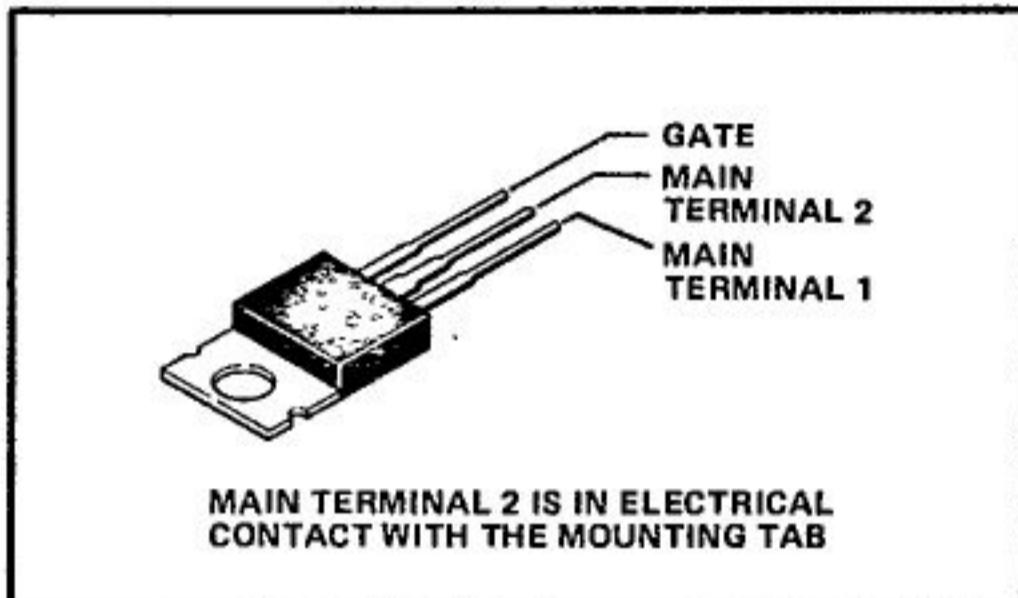
REVISED OCTOBER 1984

- High-Current Triacs
- 100 V to 800 V
- 12 A and 16 A RMS
- 100 A and 125 A Peak Current
- Max I_{GT} of 50 mA (Quadrants 1-3)

device schematic



TO-220AB PACKAGE



absolute maximum ratings at 25°C case temperature (unless otherwise noted)

	SUFFIX	SERIES	
		TIC236	TIC246
Repetitive peak off-state voltage, V_{DRM} (see Note 1)	A	100V	100V
	B	200V	200V
	C	300V	300V
	D	400V	400V
	E	500V	500V
	M	600V	600V
	S	700V	700V
	N	800V	800V
Full-cycle RMS on-state current at (or below) 70°C case temperature $I_T(RMS)$ (see Note 3)		12A	16A
Peak on-state surge current, full-sine-wave, I_{TSM} (see Note 3)		100A	125A
Peak gate current, I_{GM}		$\pm 1\text{ A}$	
Operating case temperature range		-40°C to 110°C	
Storage temperature range		-40°C to 125°C	
Lead temperature 1.6 mm (1/16 inch) from case for 10 seconds		230°C	

- NOTES: 1. These values apply bidirectionally for any value of resistance between the gate and Main Terminal 1.
 2. This value applies for 50-Hz full-sine-wave operation with resistive load. Above 70°C derate linearly to 110°C case temperature at the rate of 300 mA/°C for Series TIC236 and 400 mA/°C for Series TIC246.
 3. This value applies for one 50-Hz full-sine-wave when the device is operating at (or below) rated values of peak reverse voltage and on-state current. Surge may be repeated after the device has returned to original thermal equilibrium.

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TIC Devices

SERIES TIC236, TIC246 SILICON TRIACS

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS	SERIES TIC236			SERIES TIC246			UNIT
		MIN	TYP	MAX	MIN	TYP	MAX	
IDRM	Repetitive Peak Off-State Current V_{DRM} = Rated V_{DRM} , $I_G = 0$, $T_C = 110^\circ\text{C}$			± 2			± 2	mA
IGTM	$V_{\text{supply}} = +12\text{ V}^\dagger$, $R_L = 10\Omega$, $t_w(g) \geq 20\mu\text{s}$		5	50		5	50	mA
	$V_{\text{supply}} = +12\text{ V}^\dagger$, $R_L = 10\Omega$, $t_w(g) \geq 20\mu\text{s}$		-11	-50		-11	-50	
	$V_{\text{supply}} = -12\text{ V}^\dagger$, $R_L = 10\Omega$, $t_w(g) \geq 20\mu\text{s}$		-20	-50		-20	-50	
	$V_{\text{supply}} = -12\text{ V}^\dagger$, $R_L = 10\Omega$, $t_w(g) \geq 20\mu\text{s}$		28			28		
V _{GTM}	$V_{\text{supply}} = +12\text{ V}^\dagger$, $R_L = 10\Omega$, $t_w(g) \geq 20\mu\text{s}$	0.7	2		0.7	2		V
	$V_{\text{supply}} = +12\text{ V}^\dagger$, $R_L = 10\Omega$, $t_w(g) \geq 20\mu\text{s}$	-0.8	-2		-0.8	-2		
	$V_{\text{supply}} = -12\text{ V}^\dagger$, $R_L = 10\Omega$, $t_w(g) \geq 20\mu\text{s}$	-0.8	-2		0.8	-2		
	$V_{\text{supply}} = -12\text{ V}^\dagger$, $R_L = 10\Omega$, $t_w(g) \geq 20\mu\text{s}$	0.9	2		0.9	2		
V _{TM}	$I_{TM} = \pm 17\text{ A}$, $I_G = 100\text{ mA}$, See Note 4			± 1.5	± 2.1			V
	$I_{TM} = \pm 22.5\text{ A}$, $I_G = 100\text{ mA}$, See Note 4						± 1.4	
I _H	$V_{\text{supply}} = +12\text{ V}^\dagger$, $I_G = 0$, Initiating $I_{TM} = 100\text{ mA}$	12	40		12	40		mA
	$V_{\text{supply}} = -12\text{ V}^\dagger$, $I_G = 0$, Initiating $I_{TM} = -100\text{ mA}$	-12	-40		-12	-40		
I _L	$V_{\text{supply}} = +12\text{ V}^\dagger$, See Note 5		80		80			mA
	$V_{\text{supply}} = -12\text{ V}^\dagger$, See Note 5		-80		-80			
dv/dt	Critical Rate of Rise of Off-State Voltage	$V_D = \text{Rated } V_D$, $T_C = 110^\circ\text{C}$		400		400		V/ μs
dv/dt(c)	Critical Rise of Commutation Voltage	$V_R = \text{Rated } V_D$, $di/dt = 0.5 T(\text{RMS})/\text{ms}$	$T_C = 80^\circ\text{C}$	1.2	2	1.2	2	V/ μs
di/dt	Critical Rate of Rise of On-State Current	$V_D = \text{Rated } V_D$, $diG/dt = 50\text{ mA}/\mu\text{s}$	$I_{GT} = 50\text{ mA}$, $T_C = 110^\circ\text{C}$	200		200		A/ μs

[†] All voltages are with respect to Main Terminal 1.

- NOTES: 4. This parameter must be measured using pulse techniques, $t_w \leq 1\text{ ms}$, duty cycle $\leq 2\%$. Voltage-sensing contacts, separate from the current-carrying contacts, are located within 3.2 mm (1/8 inch) from the device body.
 5. The triacs are triggered by a 15-V (open-circuit amplitude) pulse supplied by a generator with the following characteristics:
 $R_G = 100\Omega$, $t_w = 20\mu\text{s}$, $t_r \leq 15\text{ ns}$, $t_f \leq 15\text{ ns}$, $f = 1\text{ kHz}$.

thermal characteristics

PARAMETER	SERIES TIC236			SERIES TIC246			UNIT
	MIN	TYP	MAX	MIN	TYP	MAX	
R _{θJC}			2			1.9	
R _{θJA}			62.5			62.5	°C/W

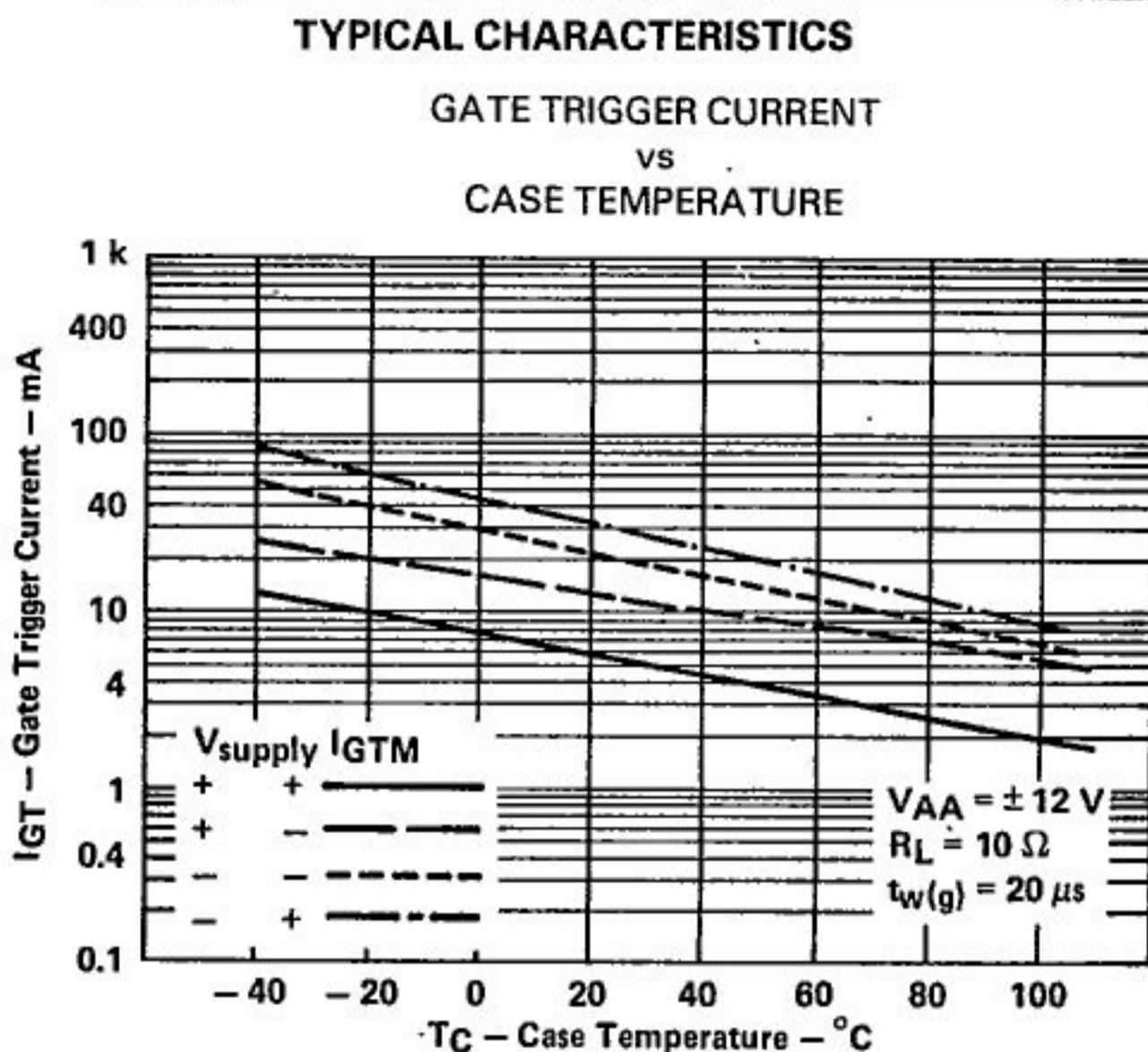


FIGURE 1

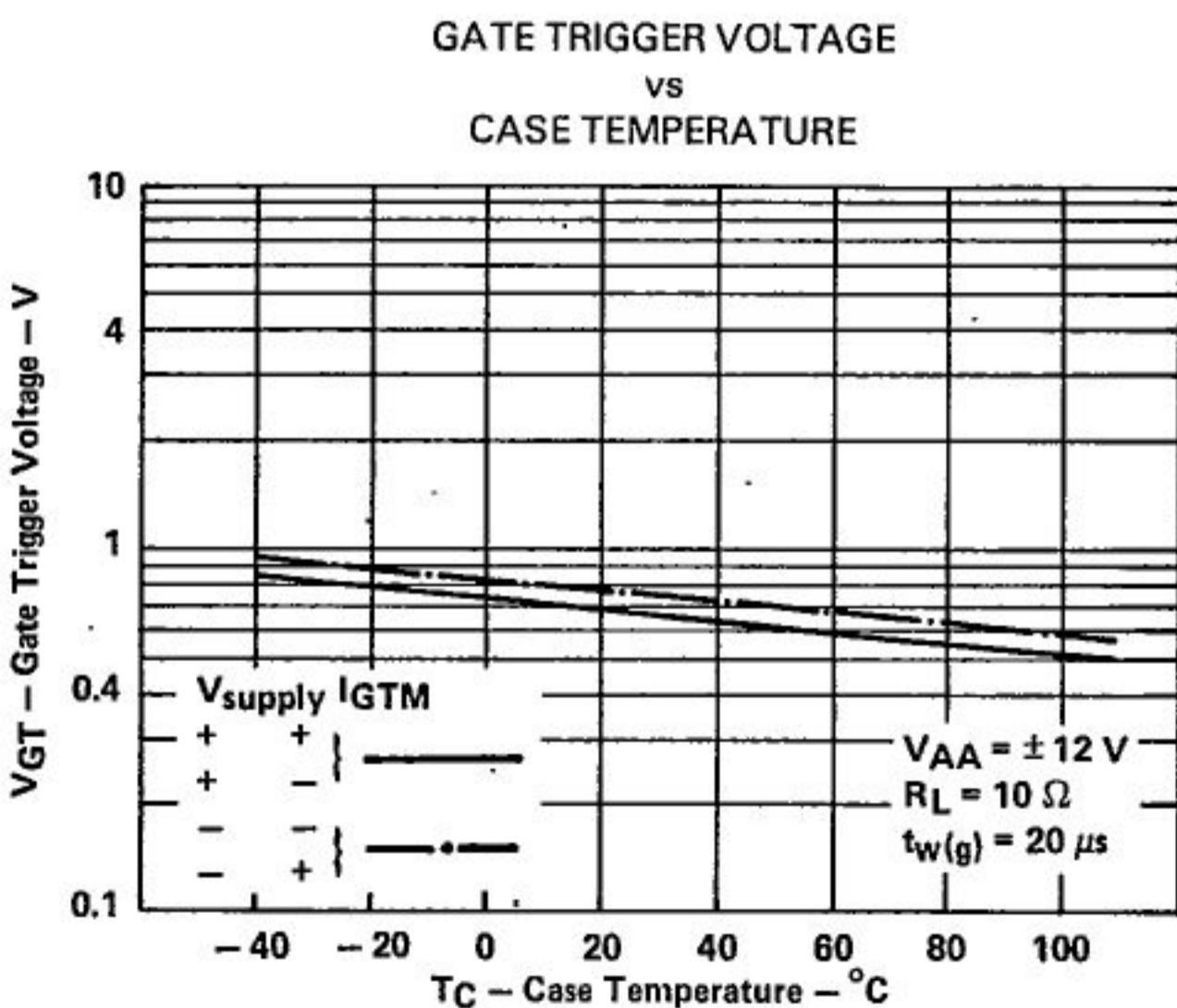


FIGURE 2

**SERIES TIC236, TIC246
SILICON TRIACS**

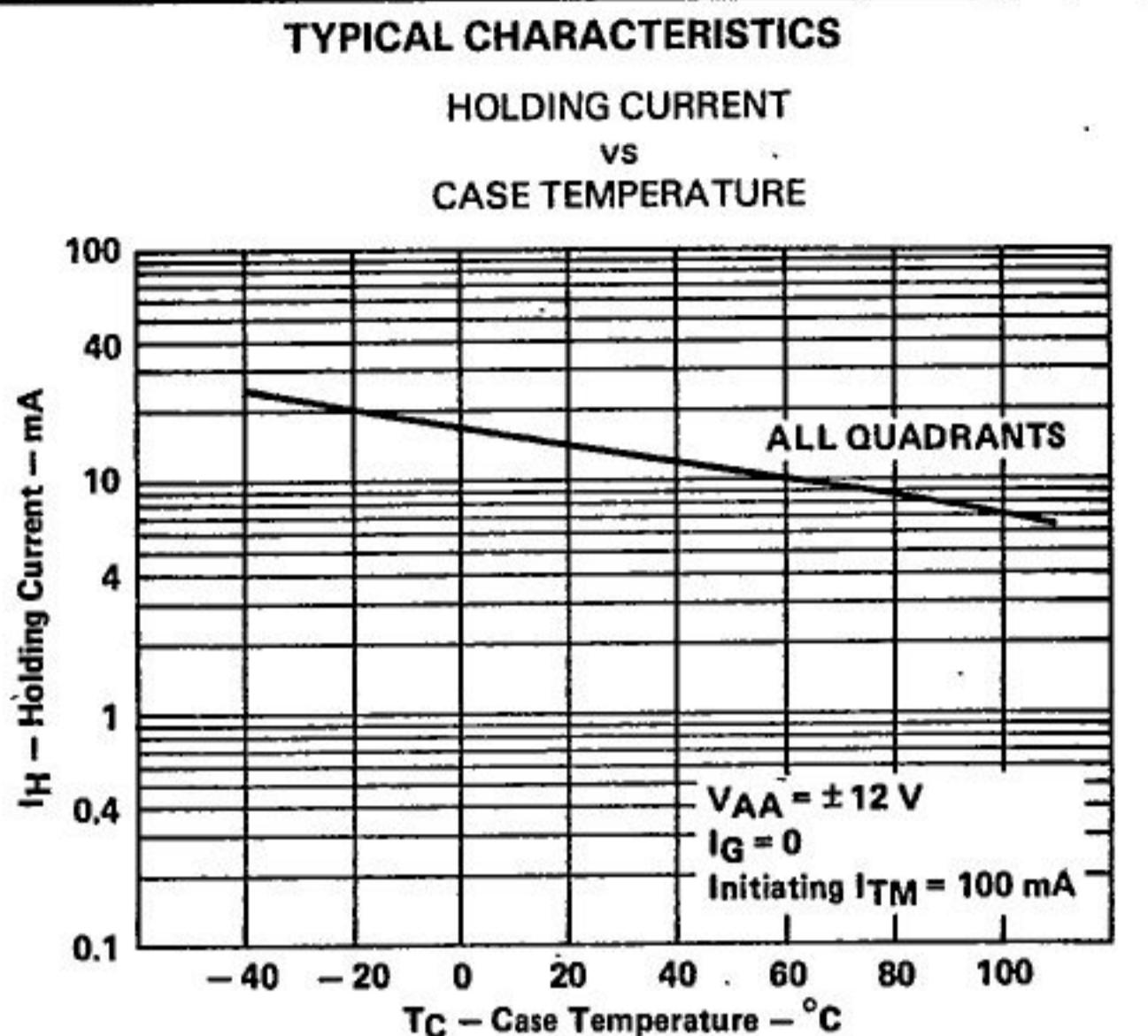


FIGURE 3

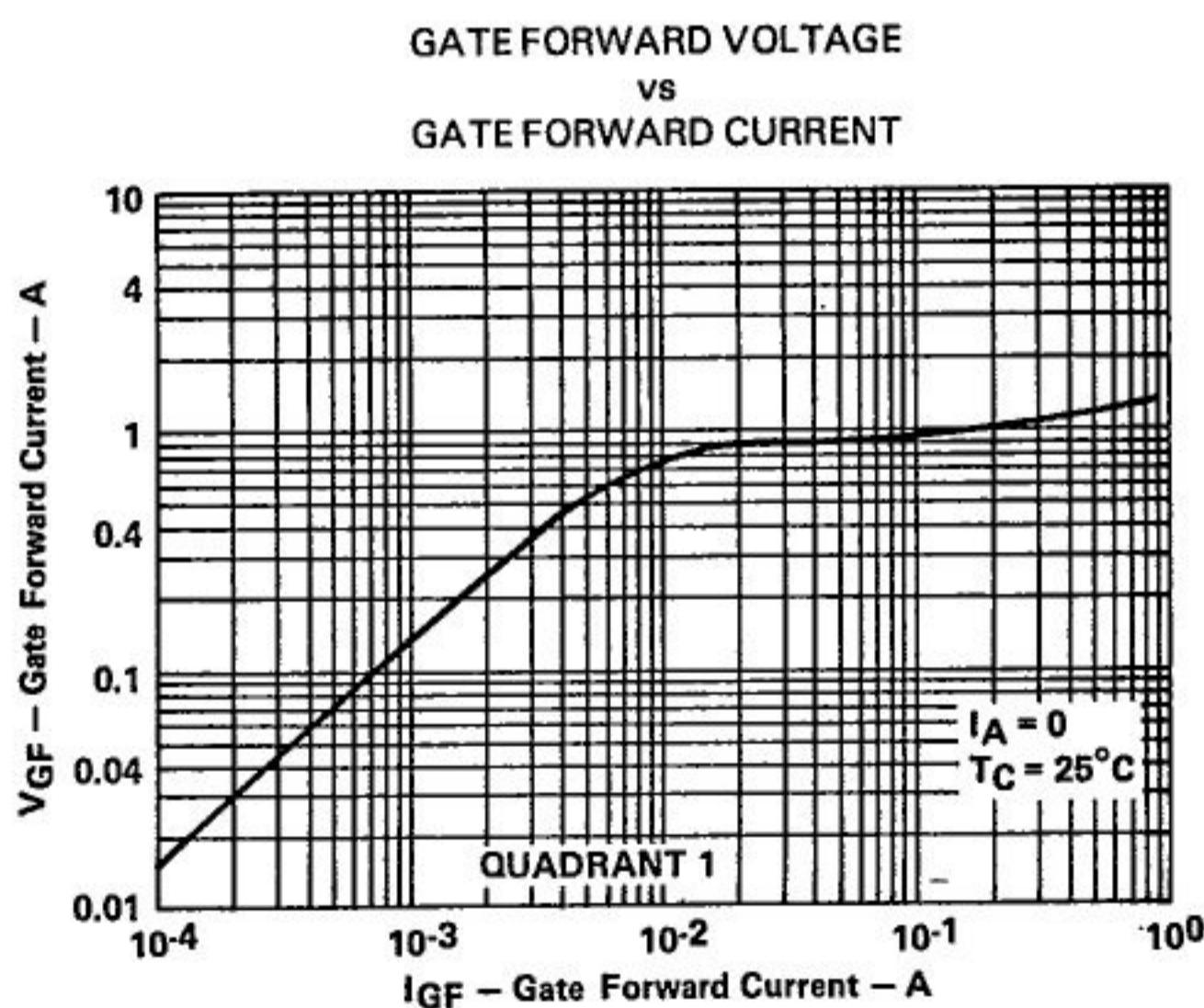


FIGURE 4

TYPICAL CHARACTERISTICS

LATCHING CURRENT
vs
CASE TEMPERATURE

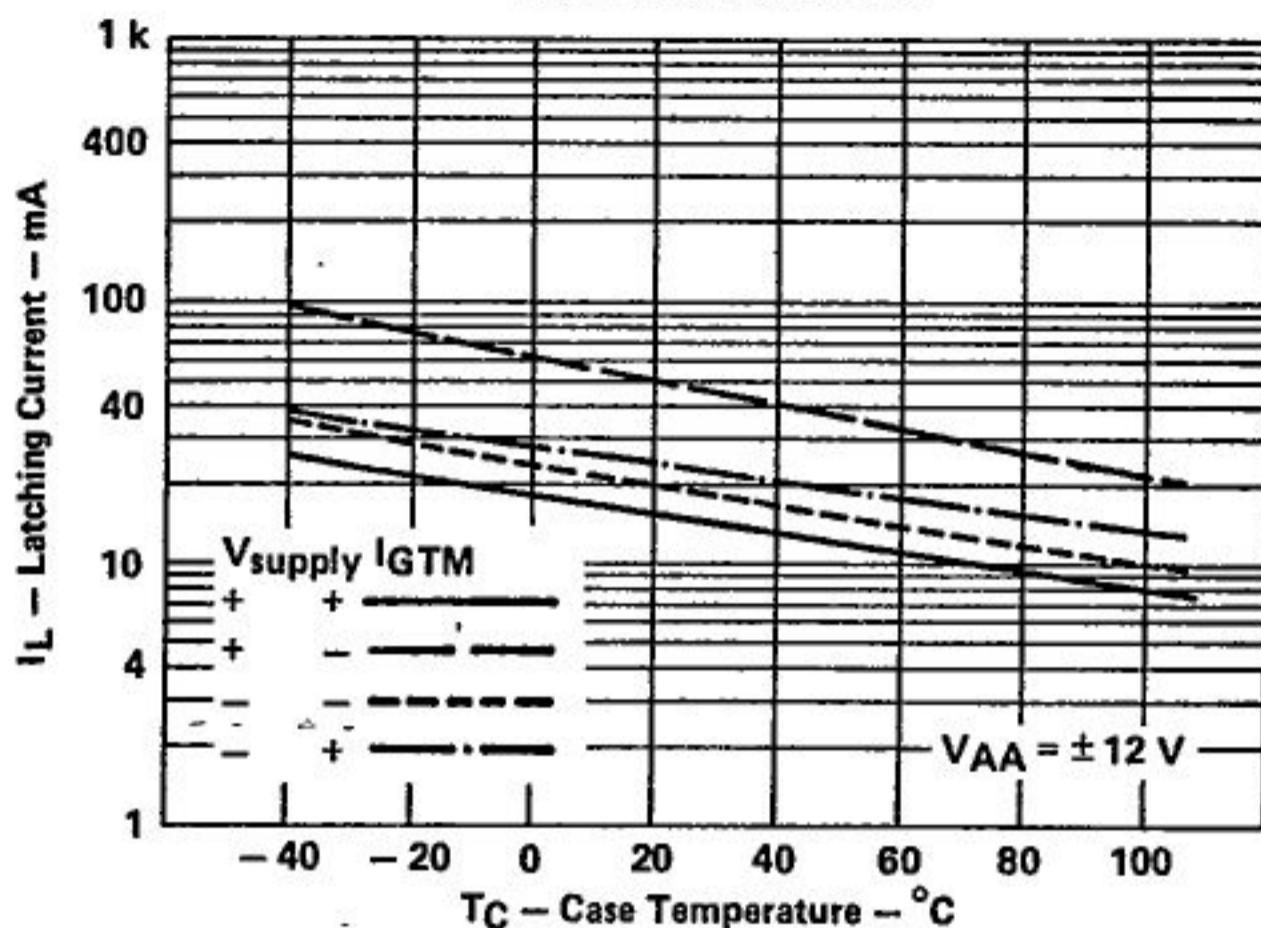


FIGURE 5

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TIC Devices